

Fast Switching Emitter Controlled Diode

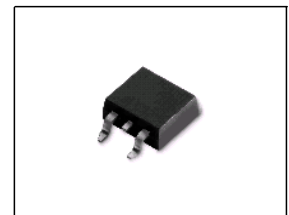
Feature

- 1200 V Emitter Controlled technology
- Fast recovery
- Soft switching
- Low reverse recovery charge
- Low forward voltage
- Easy paralleling
- Qualified according to JEDEC⁰⁾ for target applications

Product Summary

V_{RRM}	1200	V
I_F	30	A
V_F	1.65	V
T_{jmax}	150	°C

PG-TO263-3-2



Type	Package	Ordering Code	Marking	Pin 1	PIN 2	PIN 3
IDB30E120	PG-TO263-3-2	-	D30E120	NC	C	A

Maximum Ratings, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	1200	V
Continuous forward current	I_F	30	A
$T_C=25\text{ °C}$		50	
$T_C=90\text{ °C}$		30	
Surge non repetitive forward current	I_{FSM}	102	
$T_C=25\text{ °C}$, $t_p=10\text{ ms}$, sine halfwave			
Maximum repetitive forward current	I_{FRM}	76.5	
$T_C=25\text{ °C}$, t_p limited by T_{jmax} , $D=0.5$			
Power dissipation	P_{tot}	138	W
$T_C=25\text{ °C}$		138	
$T_C=90\text{ °C}$		66	
Operating and storage temperature	T_j, T_{stg}	-55...+150	°C
Soldering temperature	T_S	260	°C
reflow soldering, MSL1			

Thermal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Thermal resistance, junction - case	R_{thJC}	-	-	0.9	K/W
Thermal resistance, junction - ambient, leaded	R_{thJA}	-	-	62	
SMD version, device on PCB: @ min. footprint @ 6 cm ² cooling area ¹⁾	R_{thJA}	-	-	62	
		-	35	-	

Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Reverse leakage current $V_R=1200V, T_j=25\text{ °C}$ $V_R=1200V, T_j=150\text{ °C}$	I_R	-	-	100 2500	μA
Forward voltage drop $I_F=30A, T_j=25\text{ °C}$ $I_F=30A, T_j=150\text{ °C}$	V_F	-	1.65 1.7	2.15 -	V

⁰J-STD20 and JESD22

¹Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical without blown air.

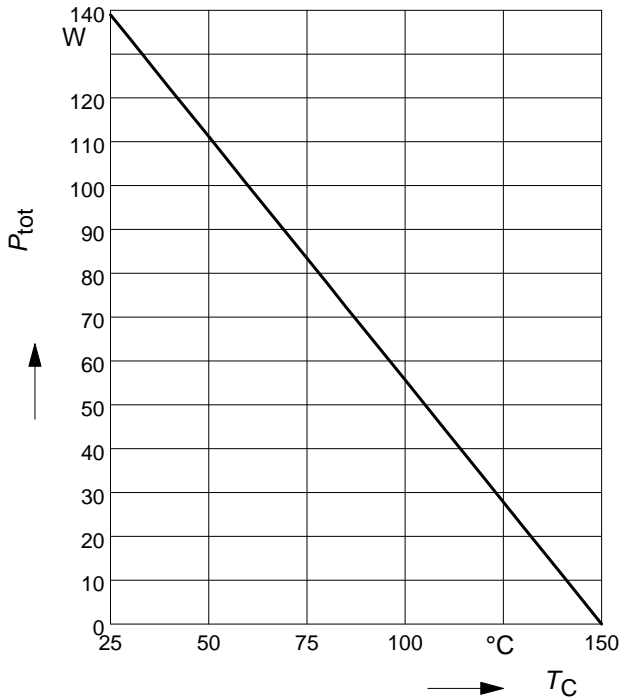
Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Reverse recovery time $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=25\text{°C}$ $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=125\text{°C}$ $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=150\text{°C}$	t_{rr}	-	243 355 380	-	ns
Peak reverse current $V_R=800\text{V}$, $I_F = 30\text{ A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=25\text{°C}$ $V_R=800\text{V}$, $I_F = 30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=125\text{°C}$ $V_R=800\text{V}$, $I_F = 30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=150\text{°C}$	I_{rrm}	-	23.7 28.3 29.5	-	A
Reverse recovery charge $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=25\text{°C}$ $V_R=800\text{V}$, $I_F = 30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=125\text{°C}$ $V_R=800\text{V}$, $I_F = 30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=150\text{°C}$	Q_{rr}	-	2630 4700 5200	-	nC
Reverse recovery softness factor $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=25\text{°C}$ $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=125\text{°C}$ $V_R=800\text{V}$, $I_F=30\text{A}$, $di_F/dt=850\text{A}/\mu\text{s}$, $T_j=150\text{°C}$	S	-	6 7.4 7.5	-	

1 Power dissipation

$$P_{tot} = f(T_C)$$

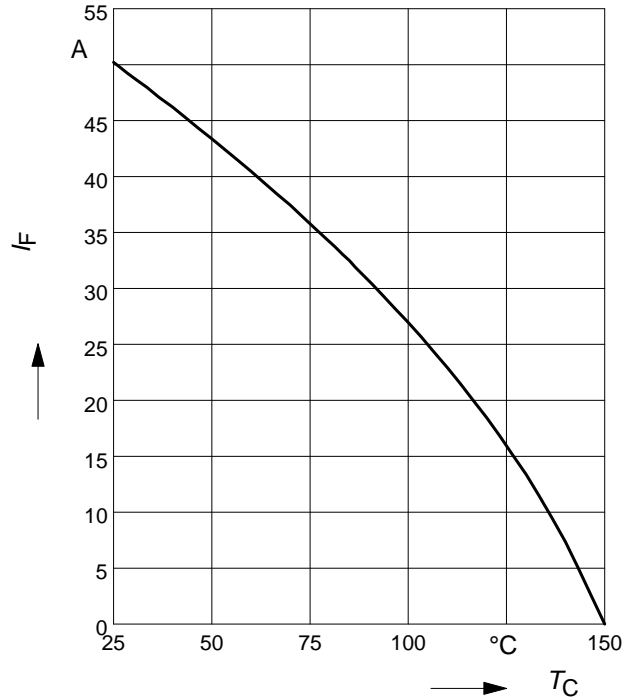
parameter: $T_j \leq 150^\circ\text{C}$



2 Diode forward current

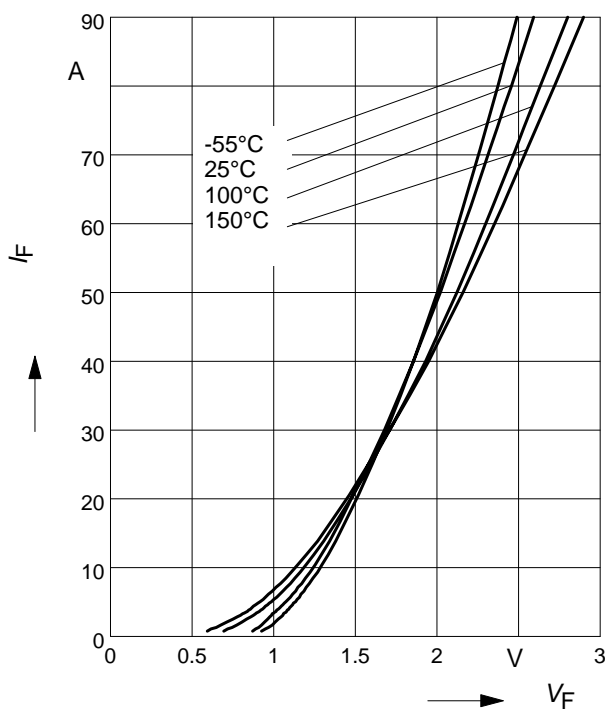
$$I_F = f(T_C)$$

parameter: $T_j \leq 150^\circ\text{C}$



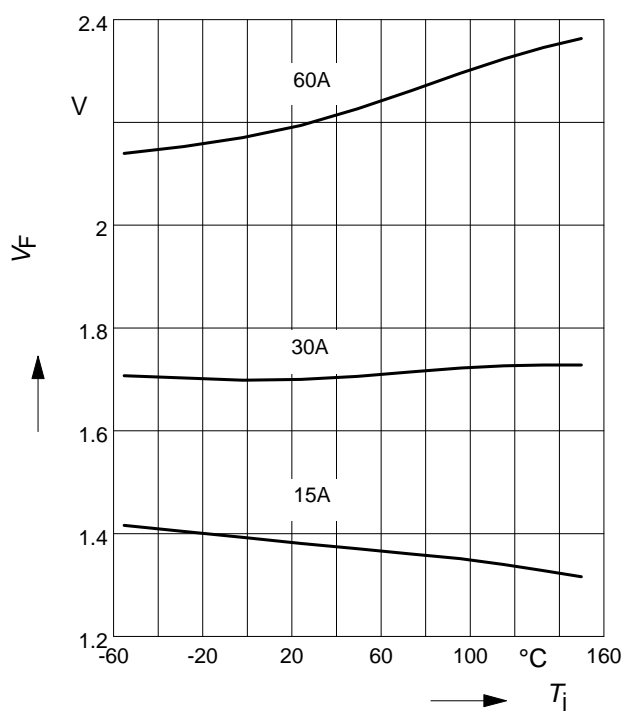
3 Typ. diode forward current

$$I_F = f(V_F)$$



4 Typ. diode forward voltage

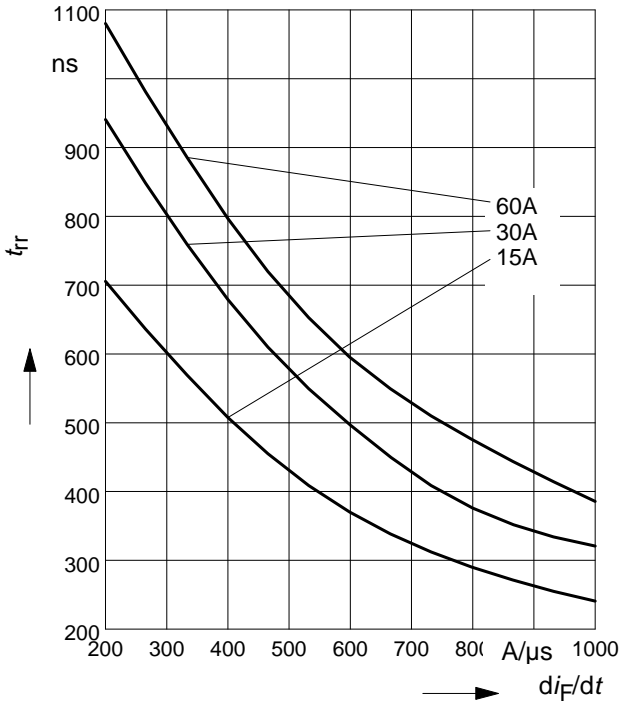
$$V_F = f(T_j)$$



5 Typ. reverse recovery time

$$t_{rr} = f(dI_F/dt)$$

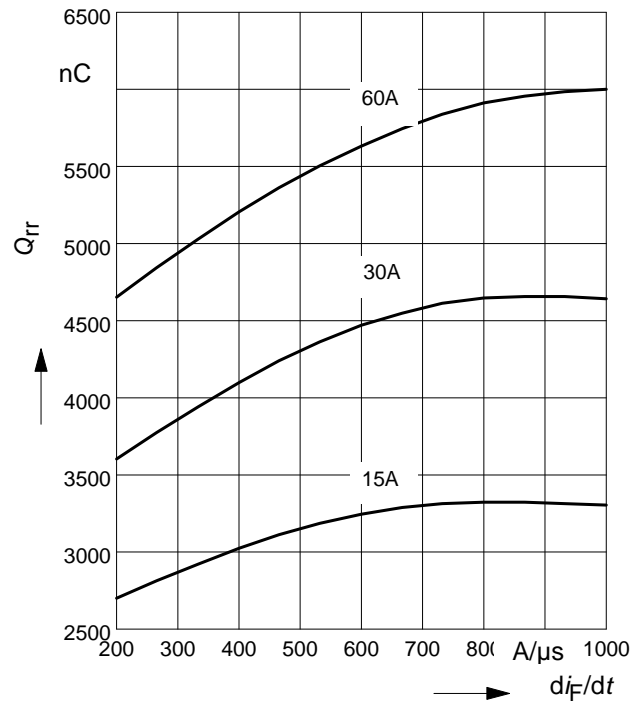
parameter: $V_R = 800V, T_j = 125^\circ C$



6 Typ. reverse recovery charge

$$Q_{rr} = f(dI_F/dt)$$

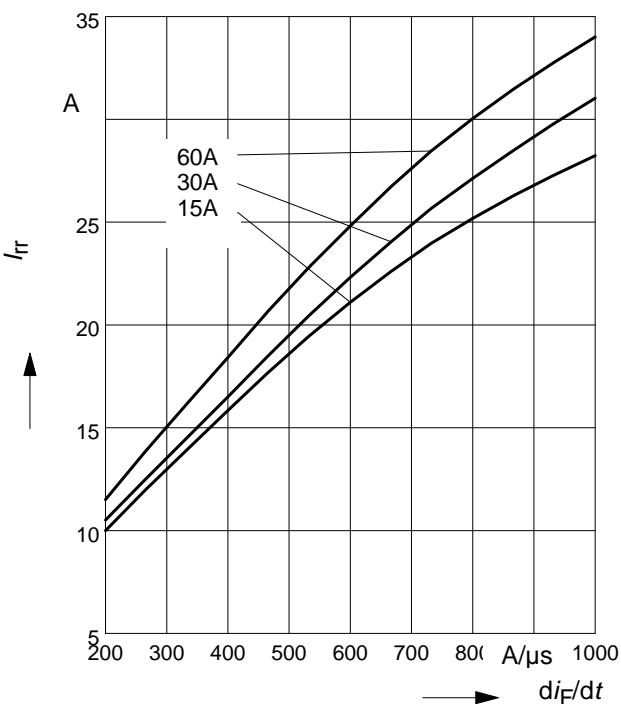
parameter: $V_R = 800V, T_j = 125^\circ C$



7 Typ. reverse recovery current

$$I_{rr} = f(dI_F/dt)$$

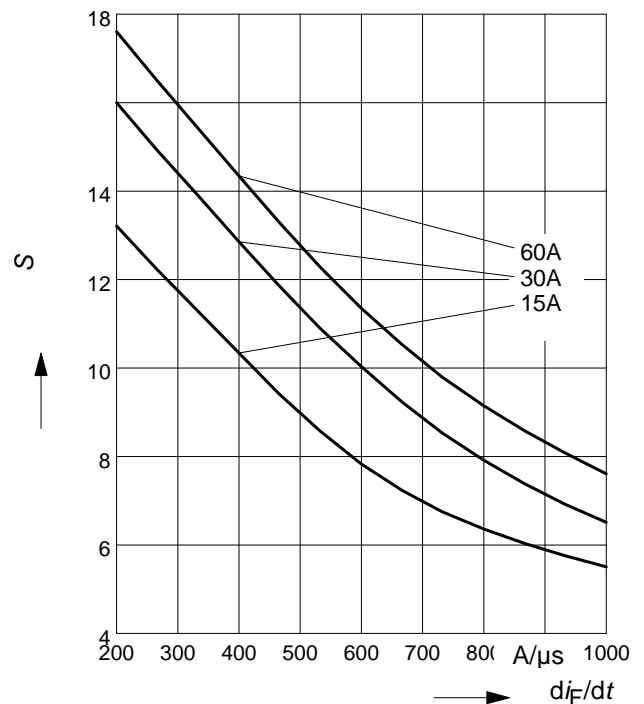
parameter: $V_R = 800V, T_j = 125^\circ C$



8 Typ. reverse recovery softness factor

$$S = f(dI_F/dt)$$

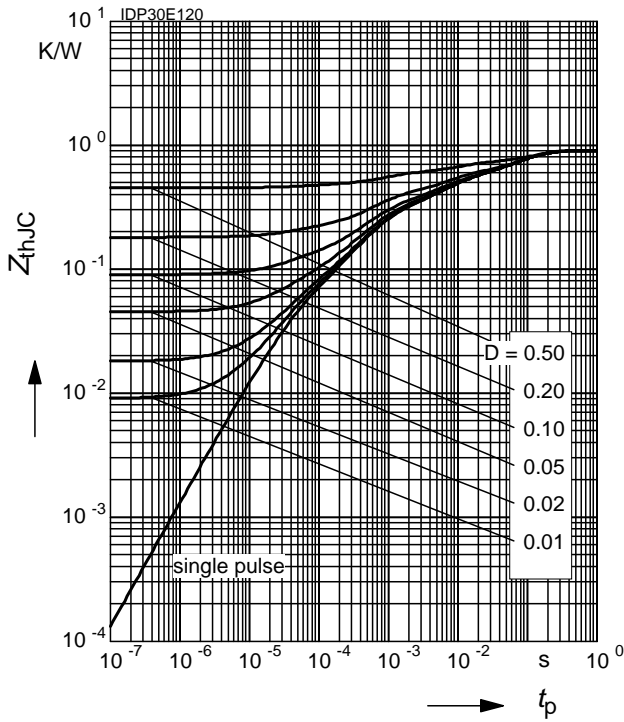
parameter: $V_R = 800V, T_j = 125^\circ C$

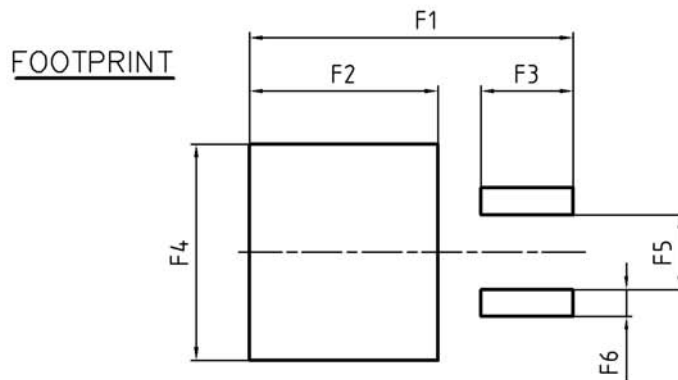
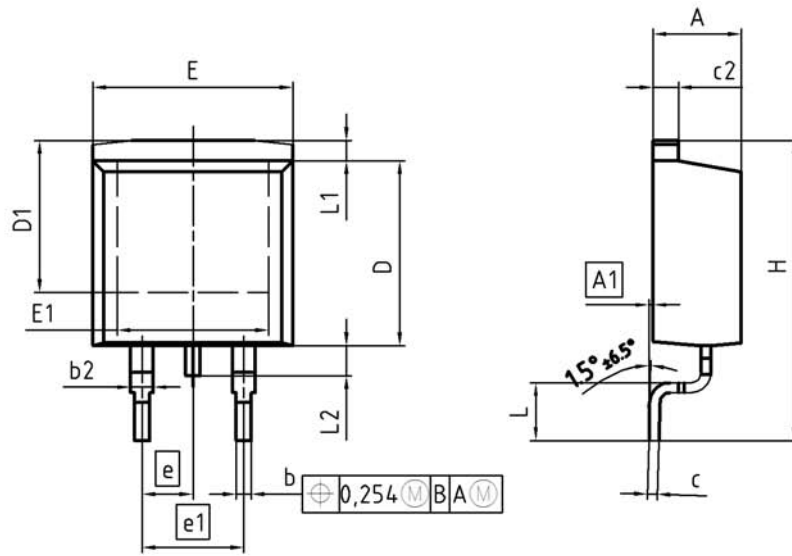


9 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$

parameter : $D = t_p/T$





DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	0.00	0.25	0.000	0.010
b	0.65	0.85	0.026	0.033
b2	0.95	1.15	0.037	0.045
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.51	9.45	0.335	0.372
D1	7.10	7.90	0.280	0.311
E	9.80	10.31	0.386	0.406
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	2		2	
H	14.61	15.88	0.575	0.625
L	2.29	3.00	0.090	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
F1	16.05	16.25	0.632	0.640
F2	9.30	9.50	0.366	0.374
F3	4.50	4.70	0.177	0.185
F4	10.70	10.90	0.421	0.429
F5	3.65	3.85	0.144	0.152
F6	1.25	1.45	0.049	0.057

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Z8B00003324

SCALE

7.5mm

EUROPEAN PROJECTION

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30-08-2007

REVISION
01